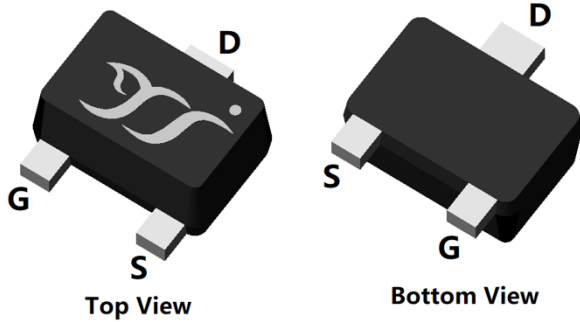
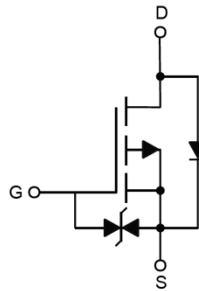


P-Channel Enhancement Mode Field Effect Transistor



SOT-723



Product Summary

• V_{DS}	-20 V
• I_D	-0.5 A
• $R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	<850 m Ω
• $R_{DS(ON)}$ (at $V_{GS}=-2.5V$)	<1200 m Ω
• $R_{DS(ON)}$ (at $V_{GS}=-1.8V$)	<2000 m Ω

General Description

- Trench Power LV MOSFET technology
- Extremely low switching loss
- Excellent stability and uniformity
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- PWM application
- Portable equipment

■ Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	-20	V
Gate-source Voltage		V_{GS}	± 10	V
Drain Current	$T_A=25$	I_D	-0.5	A
	$T_A=100$		-0.3	
Pulsed Drain Current ^A		I_{DM}	-2.5	A
Total Power Dissipation ^B	$T_A=25$	P_D	0.28	W
	$T_A=100$		0.1	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^C	Steady-State	$R_{\theta JA}$	350	450	μW

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJL3139KAT	F2	KA	8000	80000	320000	7" reel



YJL3139KAT

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =-250μA	-20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V	-	-	-1	μA
		V _{DS} =-20V, V _{GS} =0V, T _J =150	-	-	-100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±10V, V _{DS} =0V	-	-	±10	μA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-250μA	-0.35	-0.7	-1.1	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-0.5A	-	650	850	mΩ
		V _{GS} =-2.5V, I _D =-0.3A	-	900	1200	
		V _{GS} =-1.8V, I _D =-0.2A	-	1400	2000	
Diode Forward Voltage	V _{SD}	I _S =-0.5A, V _{GS} =0V	-	-0.95	-1.2	V
Maximum Body-Diode Continuous Current	I _S		-	-	-0.5	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =-10V, V _{GS} =0V, f=1MHz	-	40	-	pF
Output Capacitance	C _{oss}		-	15	-	
Reverse Transfer Capacitance	C _{rss}		-	10	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-0.5A	-	1.24	-	nC
Gate-Source Charge	Q _{gs}		-	0.37	-	
Gate-Drain Charge	Q _{gd}		-	0.27	-	
Reverse Recovery Charge	Q _{rr}	I _F =-0.5A, di/dt=100A/us	-	0.97	-	nC
Reverse Recovery Time	t _{rr}		-	26	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =-4.5V, V _{DD} =-10V, I _D =-0.5A RGEN=3Ω	-	4	-	ns
Turn-on Rise Time	t _r		-	19	-	
Turn-off Delay Time	t _{D(off)}		-	16	-	
Turn-off fall Time	t _f		-	25	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. P_d is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.

C. The value of RθJA is measured with the device mounted on the minimum recommend pad size, in the still air environment with TA =25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.



Typical Electrical and Thermal Characteristics Diagrams

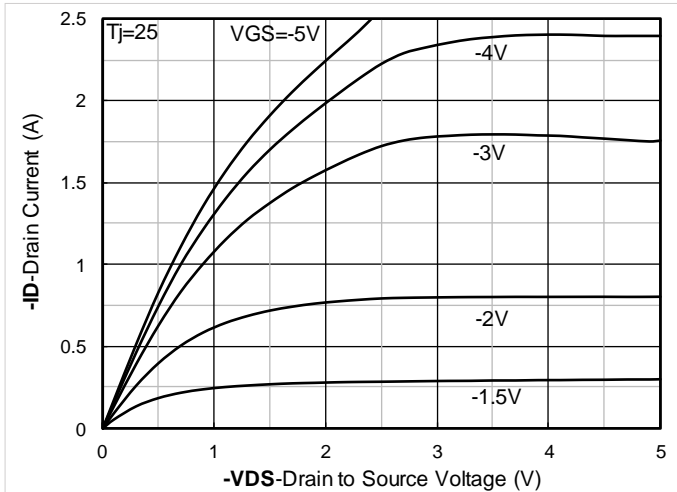


Figure 1. Output Characteristics

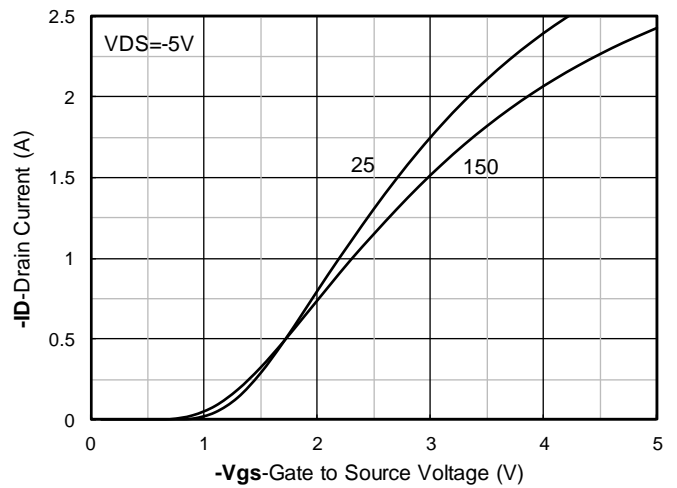


Figure 2. Transfer Characteristics

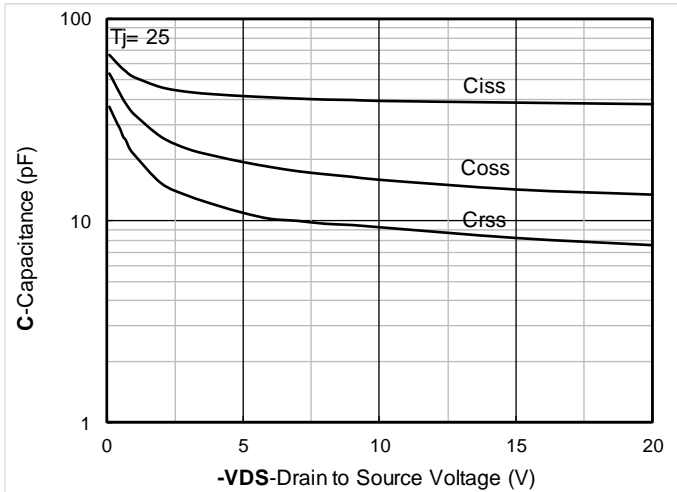


Figure 3. Capacitance Characteristics

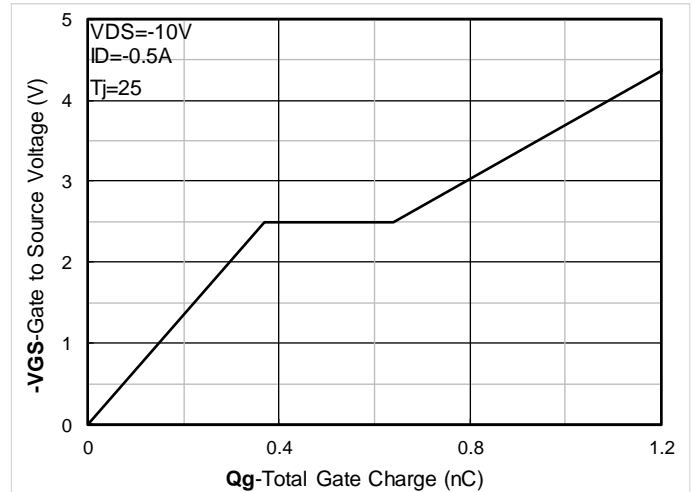


Figure 4. Gate Charge

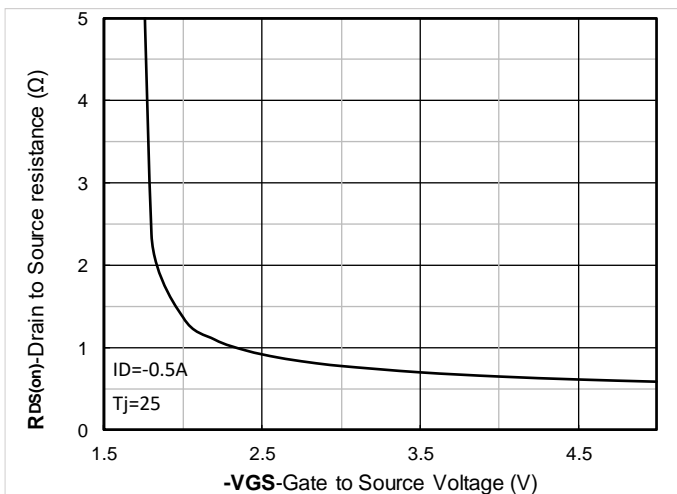


Figure 5. On-Resistance vs Gate to Source Voltage

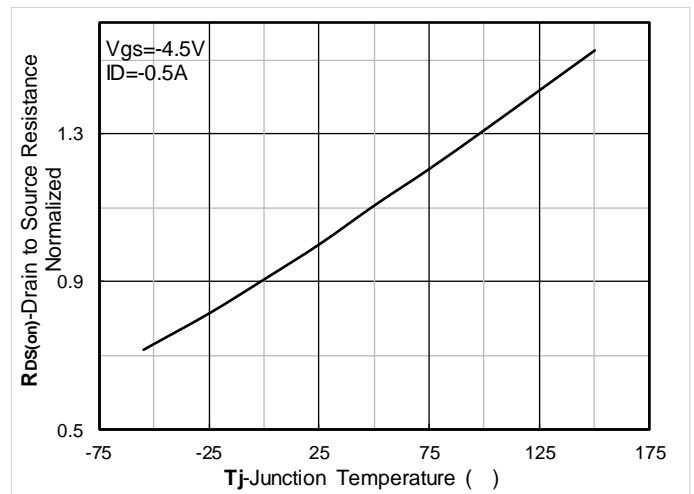


Figure 6. Normalized On-Resistance



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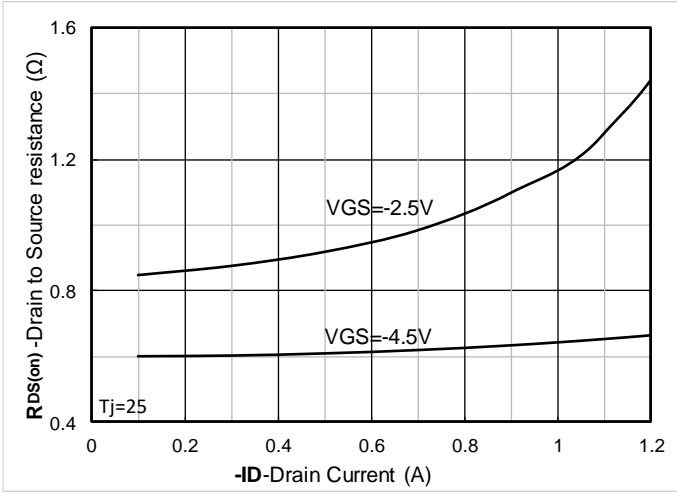


Figure 7. $R_{DS(on)}$ VS Drain Current

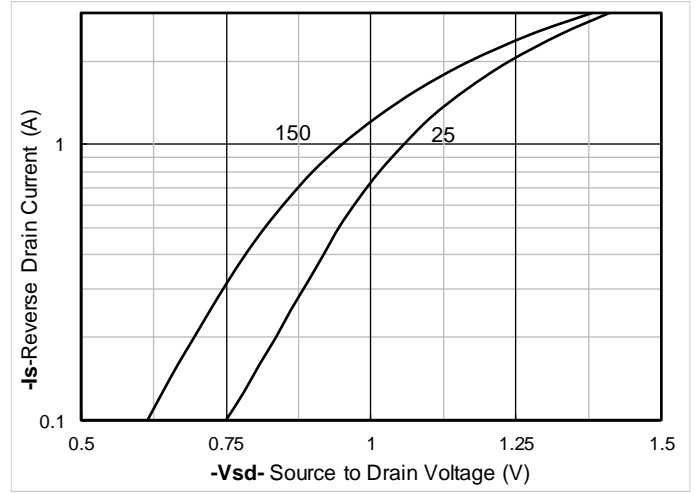


Figure 8. Forward characteristics of reverse diode

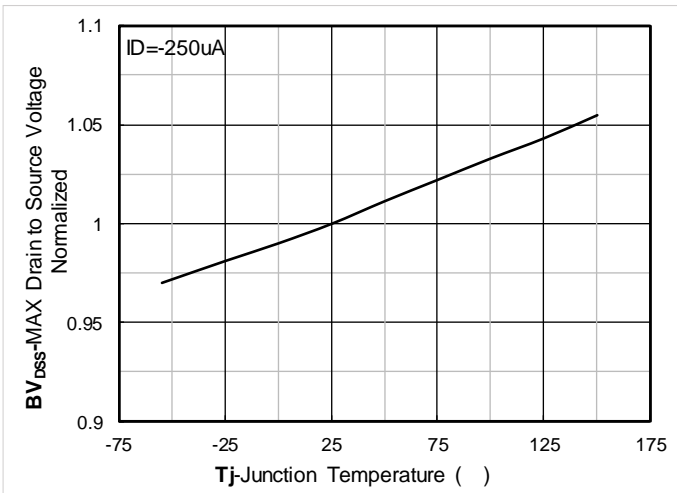


Figure 9. Normalized breakdown voltage

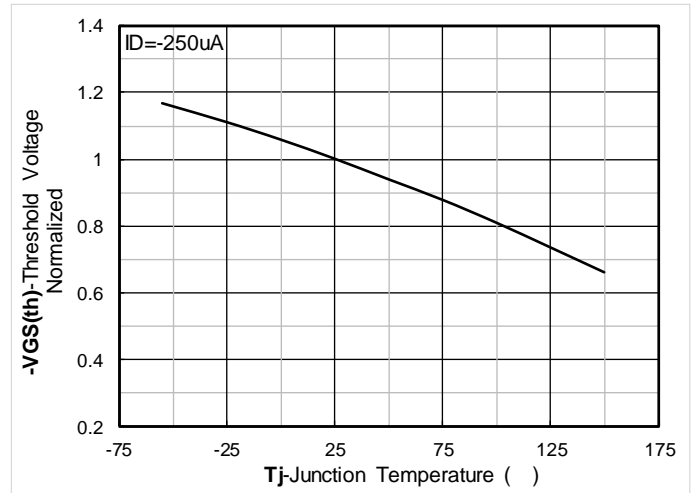


Figure 10. Normalized Threshold voltage

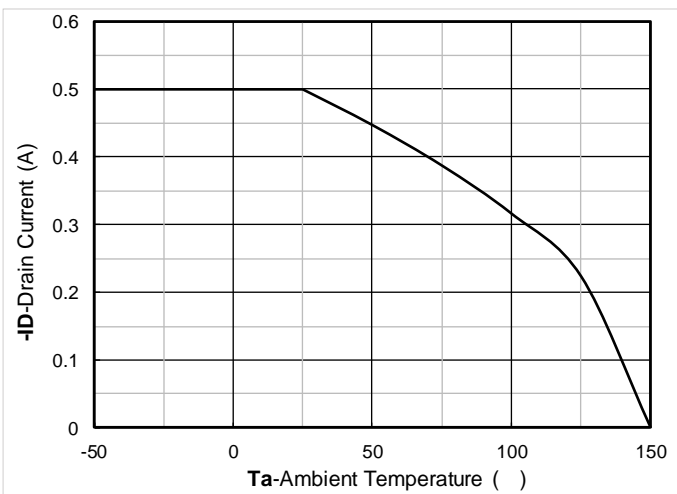


Figure 11. Current dissipation

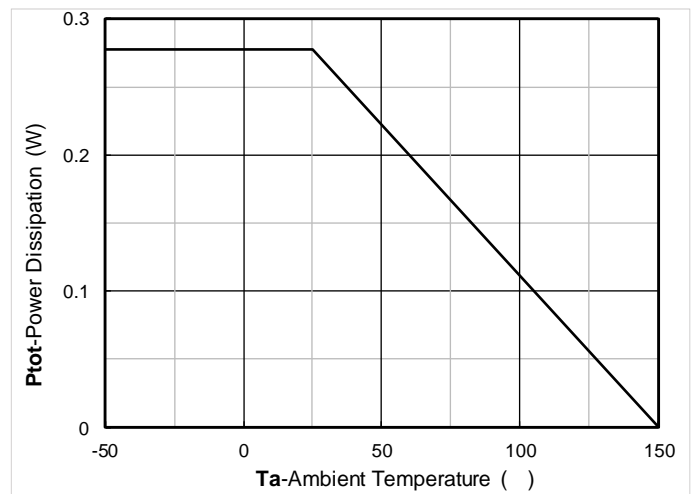


Figure 12. Power dissipation

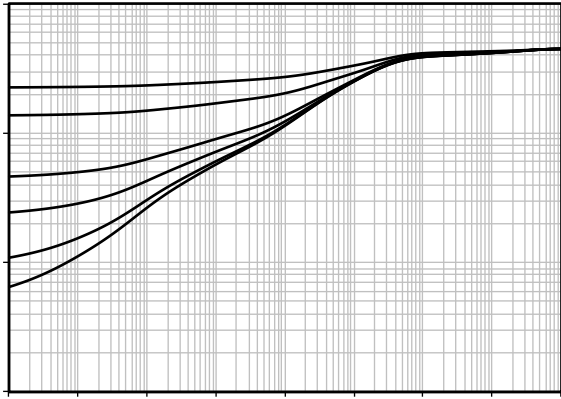


Figure 13. Maximum Transient Thermal Impedance

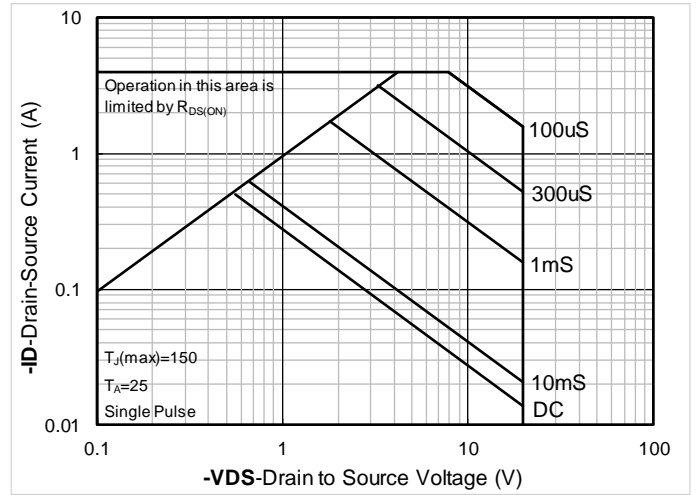
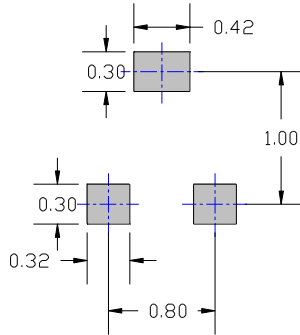
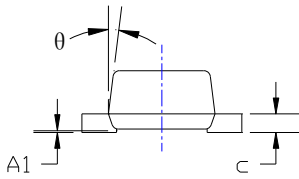
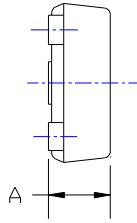
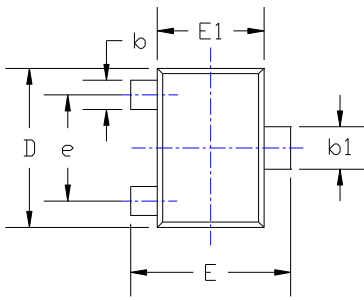


Figure 14. Safe Operation Area



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■ SOT-723 Package information



SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.017	0.022	0.430	0.550
A1	0.000	0.002	0.000	0.050
b	0.007	0.011	0.170	0.270
b1	0.011	0.015	0.270	0.370
c	0.003	0.008	0.080	0.200
D	0.045	0.049	1.150	1.250
E	0.045	0.049	1.150	1.250
E1	0.030	0.033	0.750	0.850
e	0.031 TYP.		0.800 TYP.	
θ	7° REF.		7° REF.	

NOTE:
1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
2. TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
3. THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.



YJL3139KAT

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